TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOSVI)

# **TJ20A10M3**

### Swiching Regulator Applications

- Low drain-source ON resistance: RDS (ON) = 63 m $\Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 50 \text{ S (typ.)}$
- Low leakage current:  $I_{DSS} = -10 \mu A \text{ (max) (V}_{DS} = -100 \text{ V)}$
- Enhancement-model:  $V_{th} = -2.0 \text{ to } -4.0 \text{ V (V}_{DS} = -10 \text{ V, I}_{D} = -1 \text{ mA})$

### **Absolute Maximum Ratings (Ta = 25°C)**

Characteristics			Symbol	Rating	Unit	
Drain-source voltage			$V_{DSS}$	-100	V	
Drain-gate voltage ( $R_{GS} = 20 \text{ k}\Omega$ )			$V_{DGR}$	-100	V	
Gate-source voltage			$V_{GSS}$	±20	V	
Drain current	DC (	Note 1)	I <sub>D</sub>	-20	А	
	Pulse (	Note 1)	I <sub>DP</sub>	-40	A	
Drain power dissipation (Tc = 25°C)			P <sub>D</sub>	35	W	
Single pulse avalanche energy (Note 2)			E <sub>AS</sub>	124	mJ	
Avalanche current			I <sub>AR</sub>	-20	Α	
Repetitive avalanche energy (Note 3)			E <sub>AR</sub>	2.29	mJ	
Channel temperature			T <sub>ch</sub>	150	°C	
Storage temperature range			T <sub>stg</sub>	-55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the

within the absolute maximum ratings.

reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2:  $V_{DD} = -25$  V,  $T_{ch} = 25$  °C, L = 500  $\mu H$ ,  $R_G = 25$   $\Omega$ ,  $I_{AR} = -20$  A

Note 3: Repetitive rating; pulse width limited by maximum channel temperature.

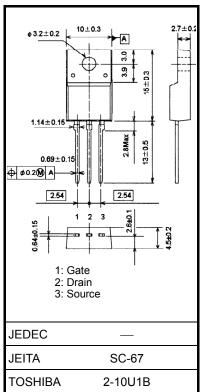
#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	3.57	°C / W
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	62.5	°C/W

This transistor is an electrostatic sensitive device. Please handle with caution.

Start of commercial production 2009-03

Unit: mm



Weight: 1.7 g (typ.)

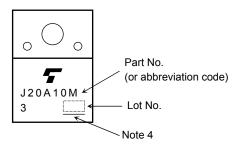
## **Electrical Characteristics (Ta = 25°C)**

Cha	racteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage cur	rent	I <sub>GSS</sub>	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±100	nA	
Drain cut-OFF cu	rrent	I <sub>DSS</sub>	V <sub>DS</sub> = -100 V, V <sub>GS</sub> = 0 V	_	_	-10	μА	
Danier and the state of the sta		V (BR) DSS	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-100	_	_	V	
Drain-source brea	in-source breakdown voltage		$I_D = -10 \text{ mA}, V_{GS} = 20 \text{ V}$	-75	_	_	V	
Gate threshold voltage		V <sub>th</sub>	$V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA}$	-2.0	_	-4.0	V	
Drain-source ON resistance		R <sub>DS</sub> (ON)	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -10 A	_	63	90	mΩ	
Forward transfer admittance		Y <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -10 A	25	50	_	S	
Input capacitance		C <sub>iss</sub>	V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	5500	_	pF	
Reverse transfer capacitance		C <sub>rss</sub>		_	200	_		
Output capacitance		Coss		_	290	_		
Switching time	Rise time	t <sub>r</sub>	$V_{GS}$ $V_{DD} \approx -50 \text{ V}$ $V_{DD} \approx -50 \text{ V}$	_	13		ns	
	Turn-on time	t <sub>on</sub>		_	27	_		
	Fall time	t <sub>f</sub>		_	105	_		
	Turn-off time	t <sub>off</sub>	Duty ≤ 1%, t <sub>w</sub> = 10 μs	_	420	_		
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \approx -80 \text{ V}, V_{GS} = -10 \text{ V},$	_	120	_	nC	
Gate-source charge		Q <sub>gs</sub>	I <sub>D</sub> = -20 A	_	20	_		
Gate-drain ("miller") charge		Q <sub>gd</sub>		_	32	_		

# **Source-Drain Ratings and Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	$I_{DR}$	_	_	_	-20	Α
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	_			-40	Α
Forward voltage (diode)	V <sub>DSF</sub>	$I_{DR} = -20 \text{ A}, V_{GS} = 0 \text{ V}$			1.4	V
Reverse recovery time	t <sub>rr</sub>	$I_{DR} = -20 \text{ A}, V_{GS} = 0 \text{ V},$	_	76	_	ns
Reverse recovery charge	Q <sub>rr</sub>	$dI_{DR}/dt = -50 A/\mu s$	_	104	_	nC

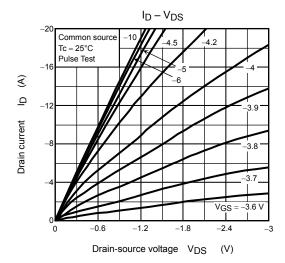
## Marking

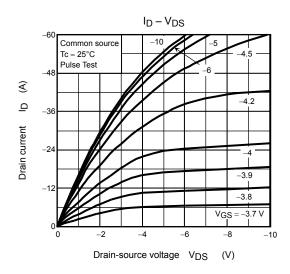


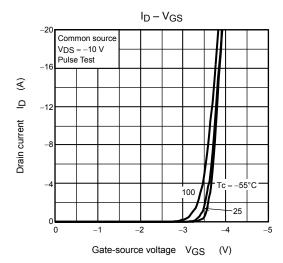
Note 4: A line under a Lot No. identifies the indication of product Labels Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

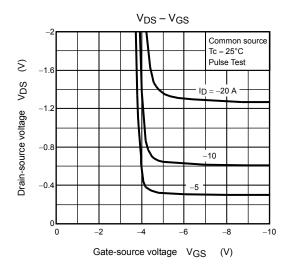
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

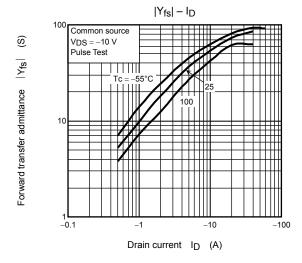
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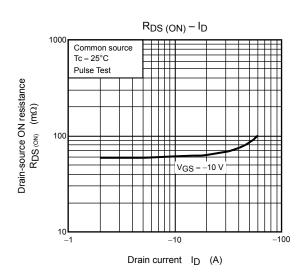


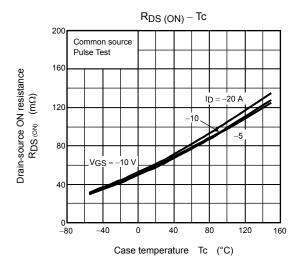


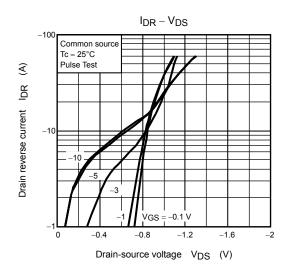


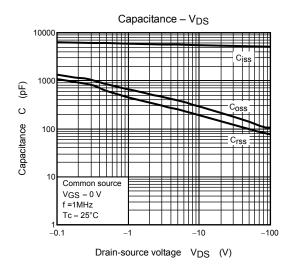


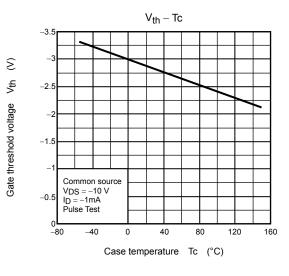


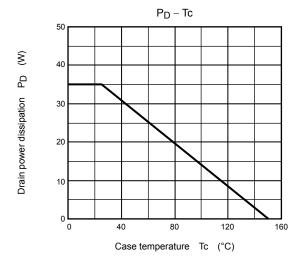


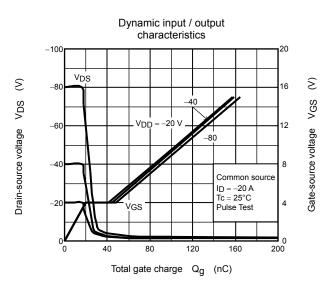


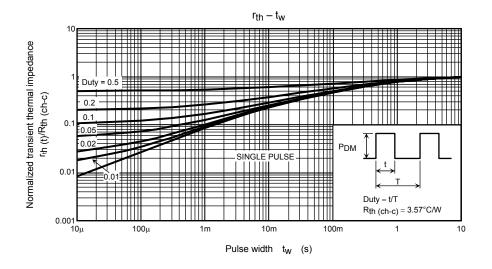


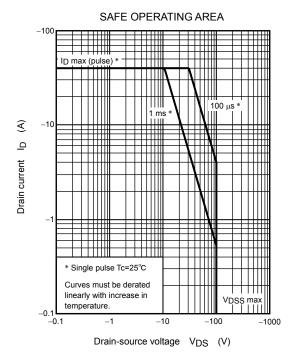


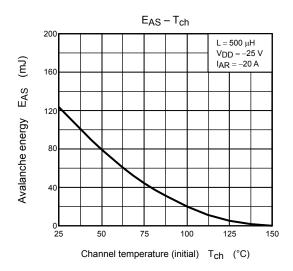


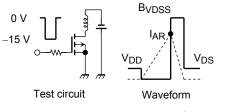












$$R_G = 25 \ \Omega \\ V_{DD} = -25 \ V, \ L = 500 \ \mu H$$
 
$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left( \frac{BVDSS}{BVDSS} \cdot V_{DD} \right)$$

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